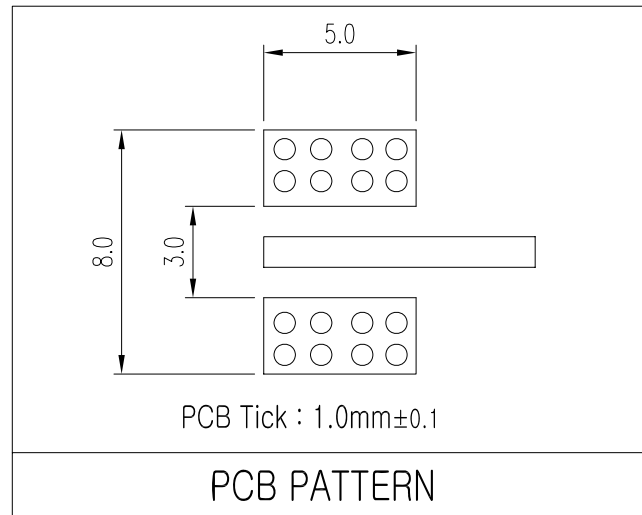
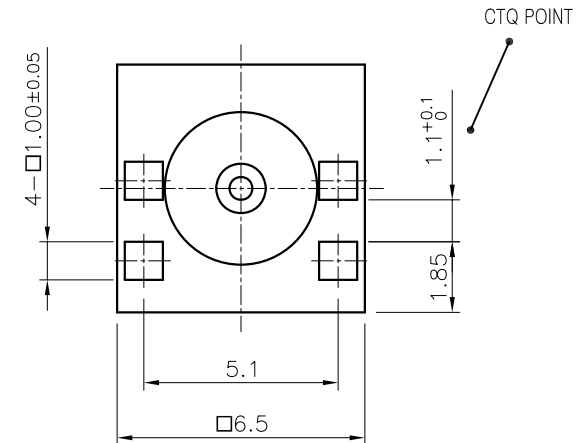
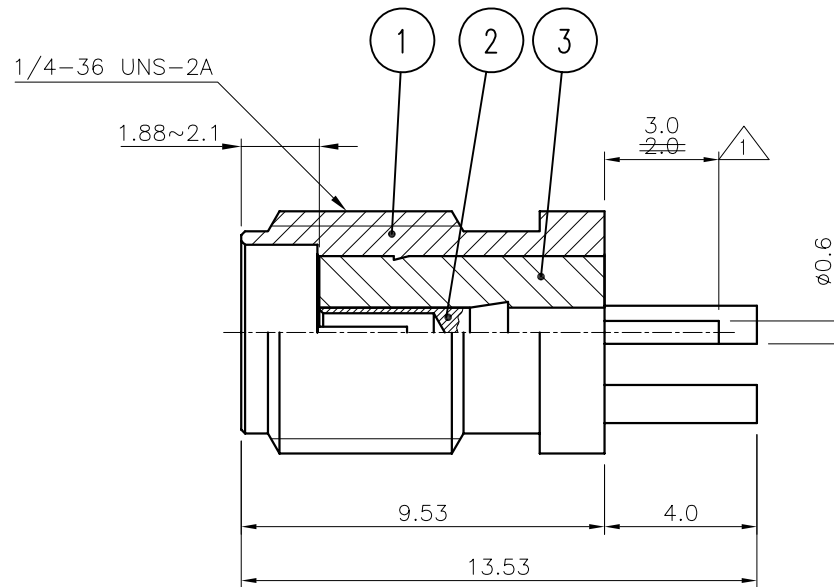


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017.09.14.
1	[설번No.201710-0002] 고객사 요청으로 인한 센터핀 길이 변경	S.Y.EUN	I.C.KIM	2017.10.11.



NOTE

1. 도금 사양

- BODY : 하지 Ni ($2\mu\text{m}\sim 10\mu\text{m}$)
Gold ($0.03\mu\text{m}\sim 2\mu\text{m}$)
- CONTACT : 하지 Ni ($2\mu\text{m}\sim 10\mu\text{m}$)
Gold ($0.03\mu\text{m}\sim 2\mu\text{m}$)

3	INSULATOR	1	TEFLON		DIN00091-N/1
2	CONTACT	1	BeCu C17300	Note 참조	DCT00256-5/2 DCT00256-5/1
1	BODY	1	MBsBD C3604BD-F	Note 참조	DBD00309-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 10. 11.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 PCB JS-4R
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	UNIT mm
		DWG NO.	CN01444-7/2	
		REVISION	1	SHEET 1 of 1

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